

Hillsboro Helping to Seize “Oregon’s Opportunity”

September 28, 2023



An Opportunity for Oregonians

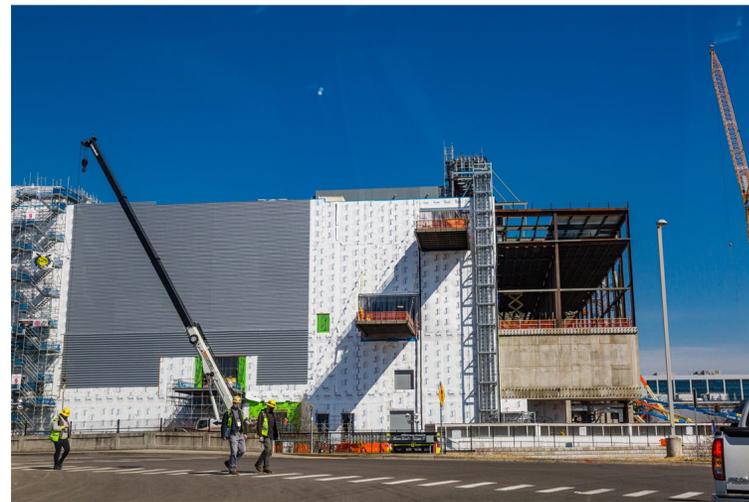
Provide economic stability through industry development and diversification



Create jobs with a range of wages and accessibility



Generate tax revenues that underpin the operations of State and Local Government



Oregon Semiconductor Success Requires a Complete Package

- DEQ enhancements



- Future Ready Oregon
- Support for Community Colleges
- K-12 Programming

- HB 2009 – Research and Development Tax Credit, SIP, Enterprise Zone

- Centers of Innovation Excellence
- NSF Engines Program
- University Innovation Fund

Senate Bill 4 “Oregon CHIPS ACT” Summary

State Funding/Incentives - \$210M:

- \$10M for University Innovation Fund
- \$190M for OR CHIPS Fund – Flexible fund to provide companies state incentives with emphasis to Federal CHIPS Act applicants
- \$10M for Business Oregon to Manage Industrial Land Planning Initiatives

SEMICONDUCTOR INDUSTRY

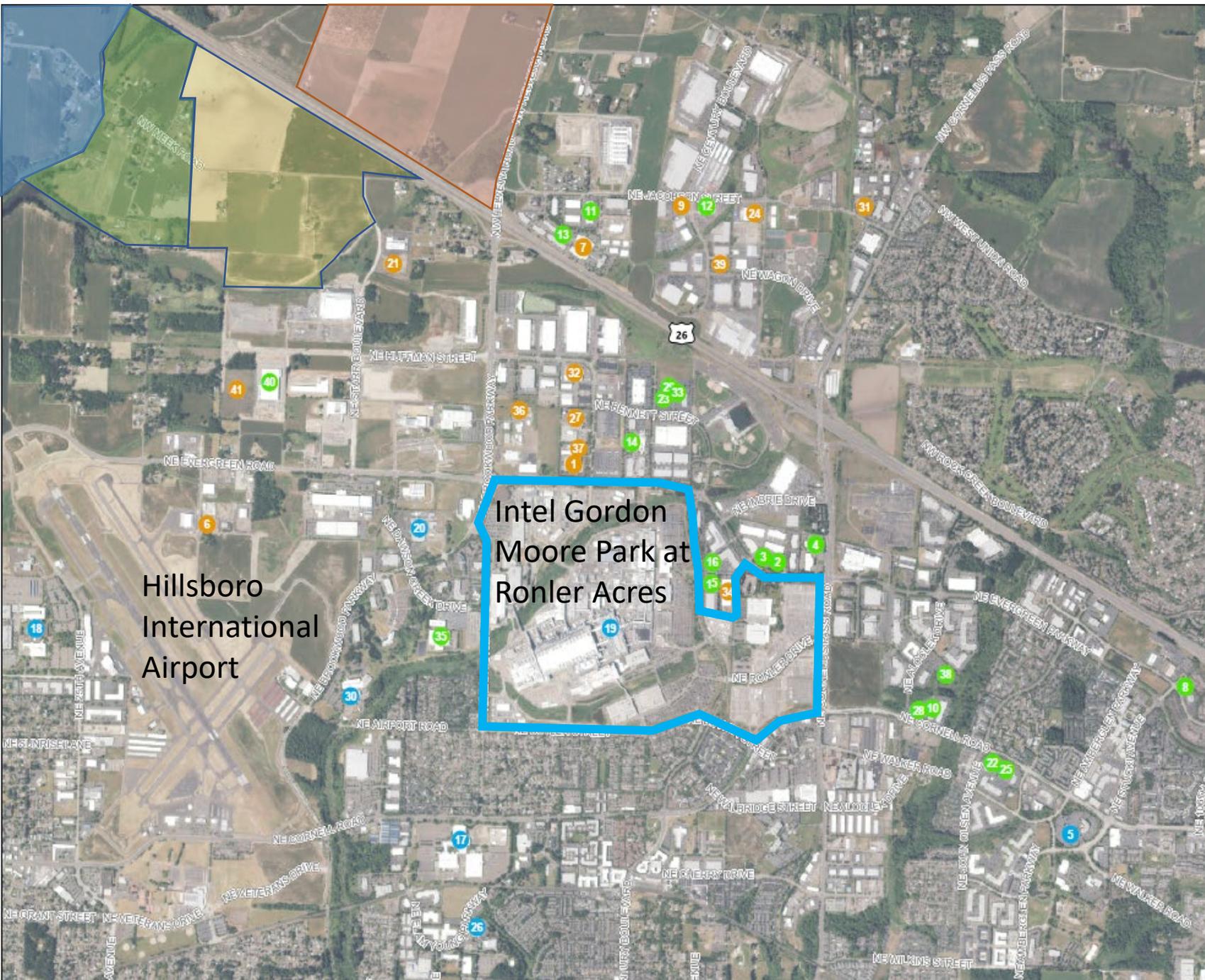
Key Supply Chain Businesses

Sub-Industry

- DM Device Manufacturing
- ES Equipment and Sub-Systems
- MS Materials and Services

Company

- 1 AGC ELECTRONICS AMERICA
- 2 APPLIED MATERIALS
- 3 ASM AMERICA
- 4 ASML US
- 5 BESANG INC
- 6 CLEAN TECH INC.
- 7 CMC MATERIALS
- 8 CYMER
- 9 DAIFUKU CLEANROOM AUTOMATION AMERICA
- 10 DISCO HI-TEC AMERICA, INC.
- 11 EBARA TECHNOLOGIES
- 12 EDWARDS VACUUM
- 13 EVATEC
- 14 HITACHI HIGH-TECH AMERICA
- 15 HITACHI HIGH-TECH AMERICA
- 16 HITACHI HIGH-TECH AMERICA
- 17 INTEL - HAWTHORN FARM
- 18 INTEL - JONES FARM
- 19 INTEL - RONLER ACRES
- 20 JIREH SEMICONDUCTOR
- 21 JSR MICRO
- 22 KLA TENCOR
- 23 KOKUSAI SEMICONDUCTOR EQUIPMENT
- 24 KOMICO
- 25 LAM RESEARCH
- 26 LATTICE SEMICONDUCTOR
- 27 LINDE
- 28 MURATA MACHINERY USA INC.
- 29 NIKON PRECISION
- 30 QORVO
- 31 QUANTUM CLEAN
- 32 RINCHEM
- 33 SCREEN SPE
- 34 SEMICONDUCTOR MATERIALS
- 35 THERMO FISHER SCIENTIFIC
- 36 TOK AMERICA
- 37 TOKAI CARBON USA
- 38 TOKYO ELECTRON AMERICA
- 39 TOSOH QUARTZ
- 40 HITACHI HIGH-TECH AMERICA (Under Construction)
- 41 GXO (Under Construction)



Hillsboro
International
Airport

Intel Gordon
Moore Park at
Ronler Acres

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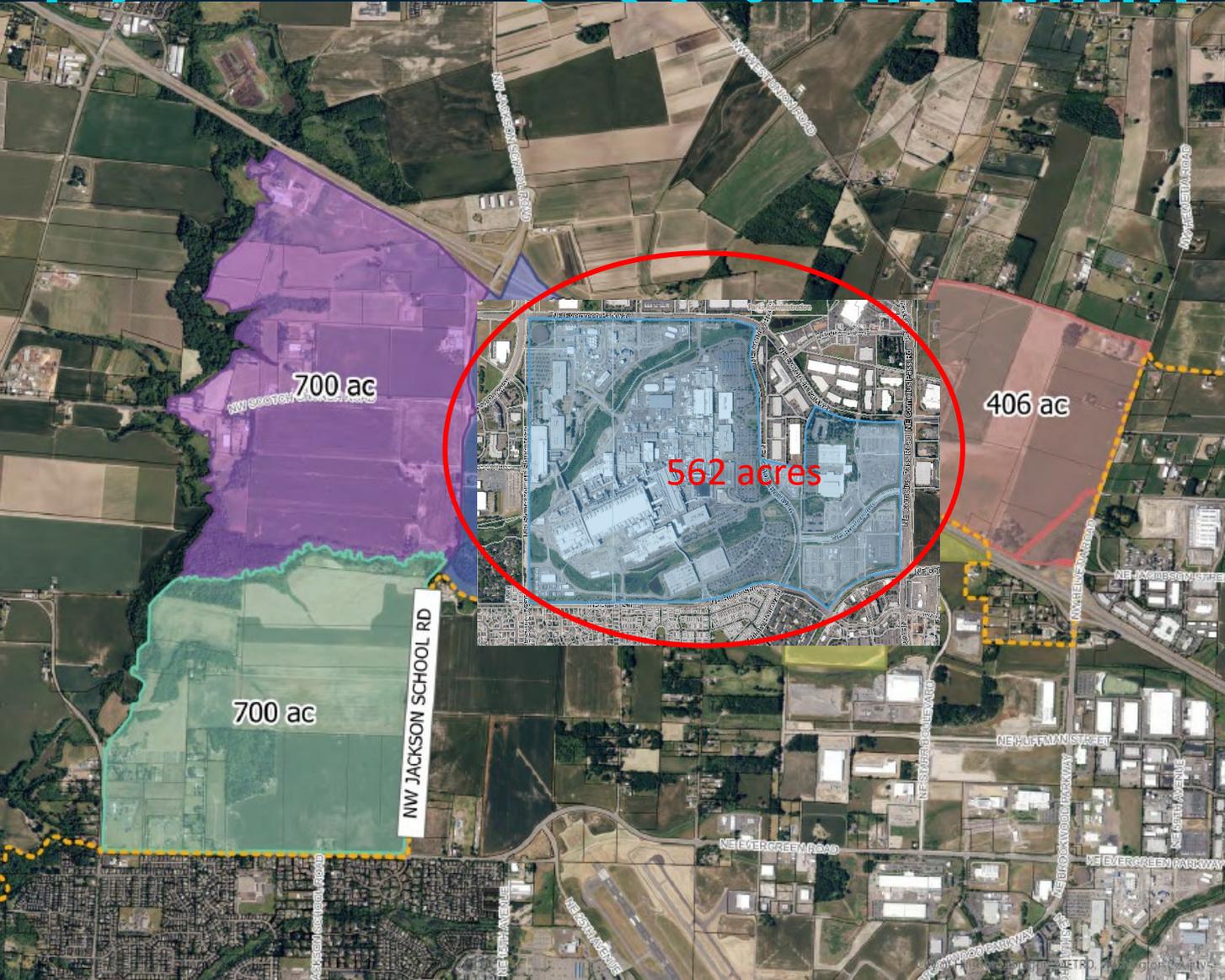
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State Land Authority

The Governor may bring land within an existing UGB designated lands available for industrial uses to become part of state’s covered incentive and that relate to the *semiconductor industry, advanced manufacturing or the supply chain for semiconductors or advanced manufacturing.*

- **Lands designated must**
 - be contiguous to the City’s UGB
 - Entirely within 3 miles of the city’s existing UGB
 - Not within areas designated as acknowledge urban reserves or rural reserves under ORS 195.144 (Grand Bargain areas except undesignated north of Hwy 26 and the 1700 acres south of Hwy 26
 - Governor may designate up to a maximum of 8 sites (2 that are > 500 ac, 6 that are <500 ac)

North Hillsboro Opportunity – Intel Overlay Example



Intel's Gordon Moore Park at Ronler Acres

- Established in 1996
- 2nd Intel fabrication campus in Oregon
- Most recent Intel Campus in Oregon
- Intel's leading research and development Campus
- Approximately 560 acres in size

Senate Bill 4 “Oregon CHIPS ACT” Items Requiring Action

- State support of local efforts with Industrial Site Readiness Funding (\$10M from SB4 and from other existing funding sources)
- Reauthorize and capitalize Regionally Significant Industrial Sites Program (RSIS)
- Refinement of HB 2009, especially SIP and EZone provisions
- Continued investment in workforce development and higher education initiatives
- Taking meaningful action on providing adequate land that is appropriately served by infrastructure and industry responsive



Thank You